



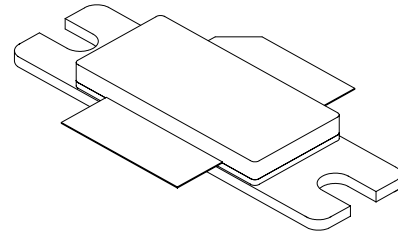
**UGF09085**

**90W, 865-880 MHz, 26V Broadband RF Power N-Channel Enhancement-Mode Lateral MOSFET**

Designed for broadband Commercial and Industrial applications in the frequency band 865 to 890 MHz. Rated with a minimum output power of 90W, it is ideal for large signal common source Power Amplifier in class AB operated at 26V.

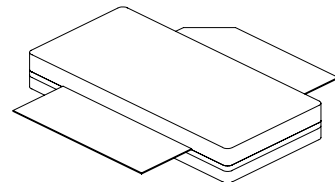
- ALL GOLD metal system for highest reliability
- Industry standard package
- Suggested alternative to the MRF9085
- Internally matched for repeatable manufacturing
- High gain, high efficiency and high linearity

- **Typical CDMA Performance (IS-97)**  
Average Load Power – 20 W  
PE – 26%  
Power Gain – 16 dB  
ACPR     -40dBc @ 750kHz (30 kHz BW)  
          -55dBc @ 1.98MHz (30 kHz BW)



**Package Type 440171**

**PN: UGF09085F**



**Package Type 440133**

**PN: UGF09085P**



**Maximum Ratings**

Rating	Symbol	Value	Unit
Drain to Source Voltage, Gate connected to Source	$V_{DSS}$	65	Volts
Gate to Source Voltage	$V_{GSS}$	+15 to -.5	Volts
Total Device Dissipation @ $T_{case} = 70^{\circ}C$ Derate above $70^{\circ}C$	$P_D$		Watts $W/^{\circ}C$
Storage Temperature Range	$T_{stg}$	-65 to +150	$^{\circ}C$
Operating Junction Temperature	$T_J$	200	$^{\circ}C$

**Thermal Characteristics**

Characteristic	Symbol	Typical	Unit
Thermal Resistance, Junction to Case	$\Theta_{JC}$	-	$^{\circ}C/W$

**Electrical DC Characteristics** ( $T_C = 25^{\circ}C$  unless otherwise specified)

Rating	Symbol	Min	Typ	Max	Unit
Drain to Source Breakdown Voltage ( $V_{GS}=0, I_D=1mA$ )	$BV_{DSS}$	65	-	-	Volts
Drain to Source Leakage current ( $V_{DS}=26V, V_{GS}=0$ )	$I_{DSS}$	-	-	1.0	mA
Gate to Source Leakage current ( $V_{GS}=15V, V_{DS}=0$ )	$I_{GSS}$	-	-	1.0	$\mu A$
Threshold Voltage ( $V_{DS}=10V, I_D=1mA$ )	$V_{GS(th)}$	-	3.5	-	Volts
Gate Quiescent Voltage ( $V_{DS}=26V, I_D=900mA$ )	$V_{GS(Q)}$	3.0	4.0	6.0	Volts
Drain to Source On Voltage ( $V_{GS}=10V, I_D=2A$ )	$V_{DS(on)}$	-	0.1	-	Volts
Forward Transconductance ( $V_{DS}=10V, I_D=5A$ )	$G_m$	-	-	-	S

**AC Characteristics** ( $T_C = 25^{\circ}C$  unless otherwise specified)

Rating	Symbol	Min	Typ	Max	Unit
Input Capacitance ( $V_{DS}=26V, V_{GS}=0V, f = 1MHz$ )	$C_{ISS}$	-	-	-	pF
Output capacitance * ( $V_{DS}= 26V, V_{GS}=0V, f = 1MHz$ )	$C_{OSS}$	-	-	-	pF
Feedback capacitance * ( $V_{DS}=26V, V_{GS}=0V, f = 1MHz$ )	$C_{RSS}$	-	-	-	pF

\* Part is internally matched on input.



# PRELIMINARY DATA SHEET

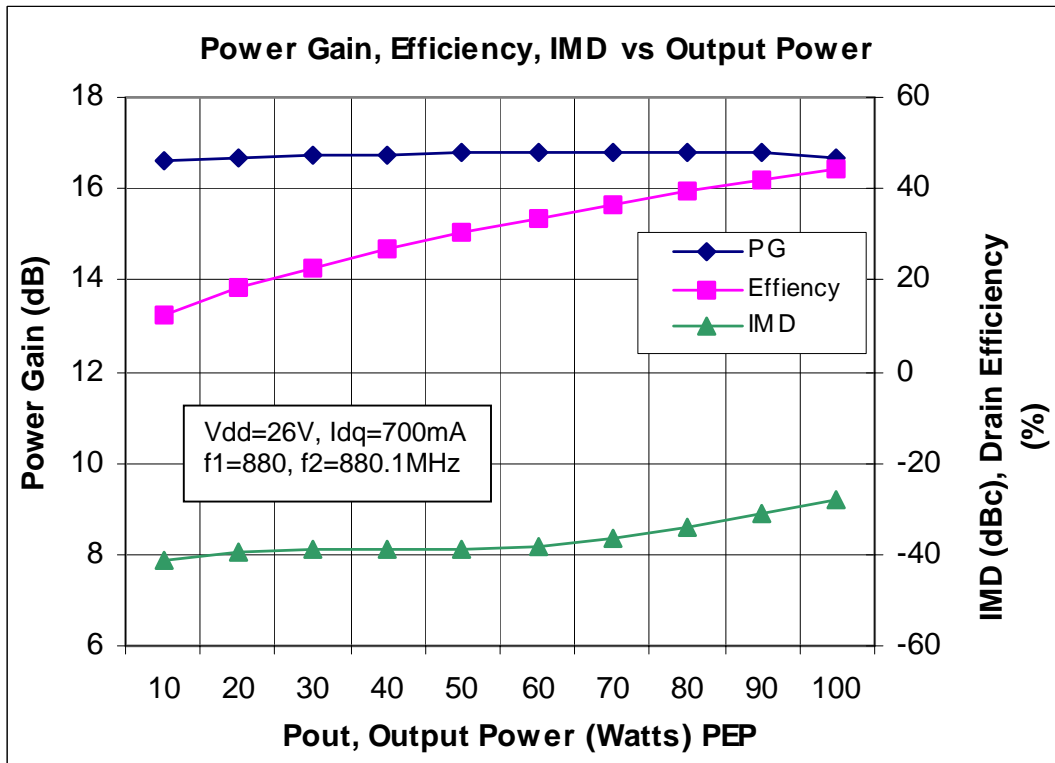
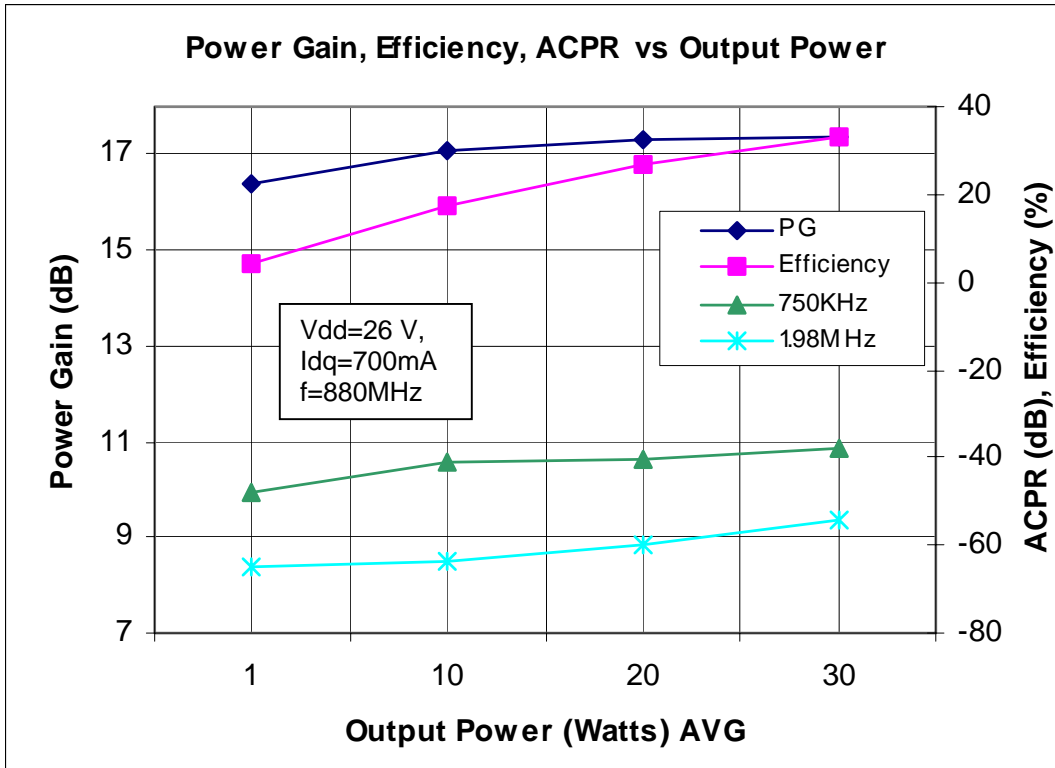
## UGF09085

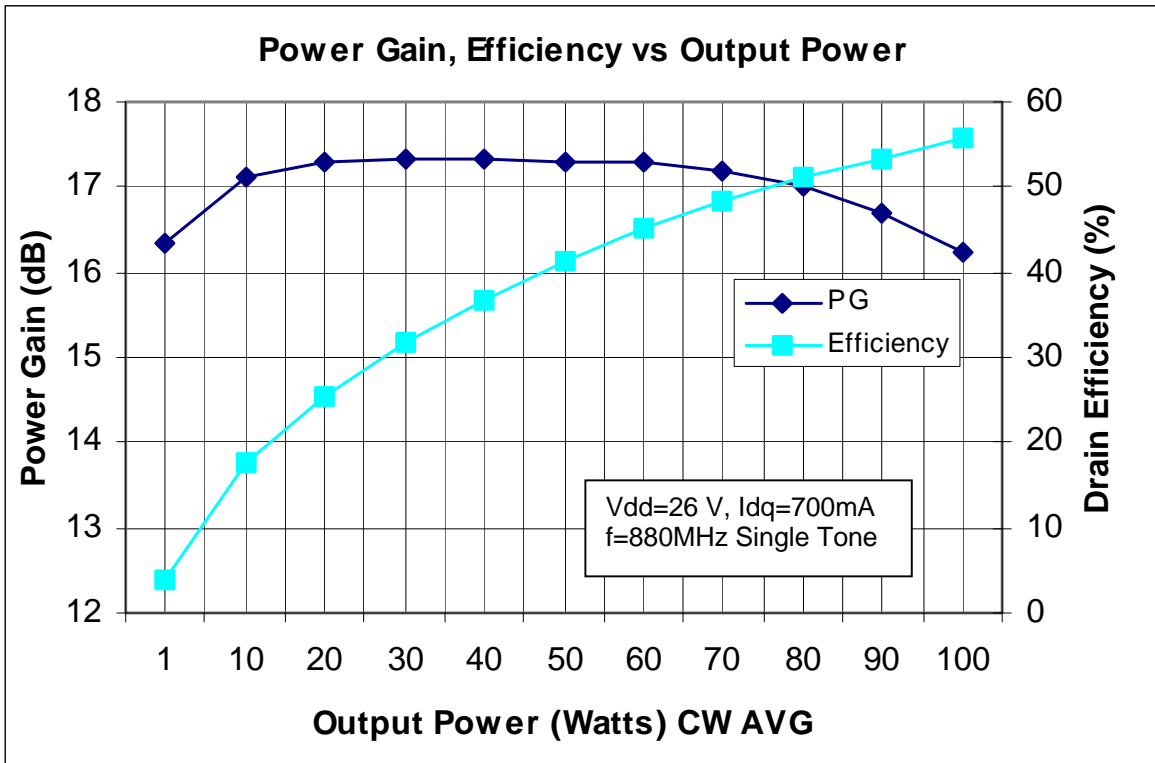
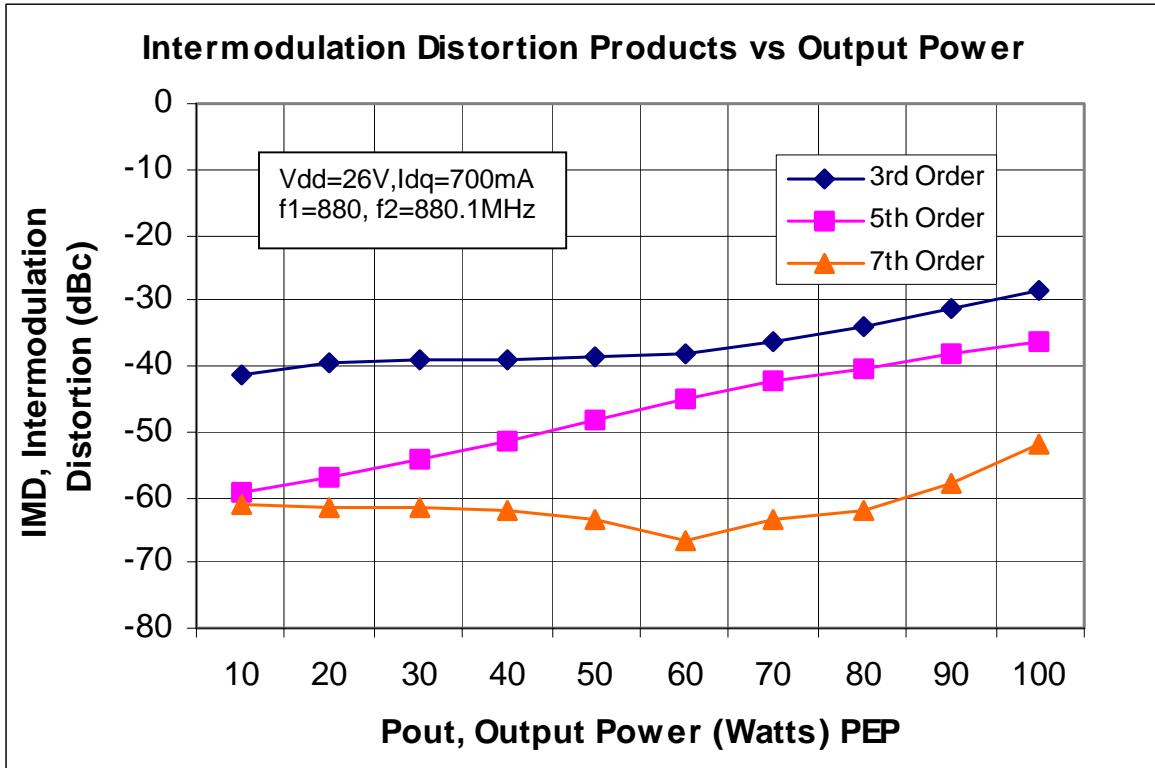
### RF and Functional Tests (T<sub>C</sub>=25°C unless otherwise specified, Cree Microwave Broadband Fixture)

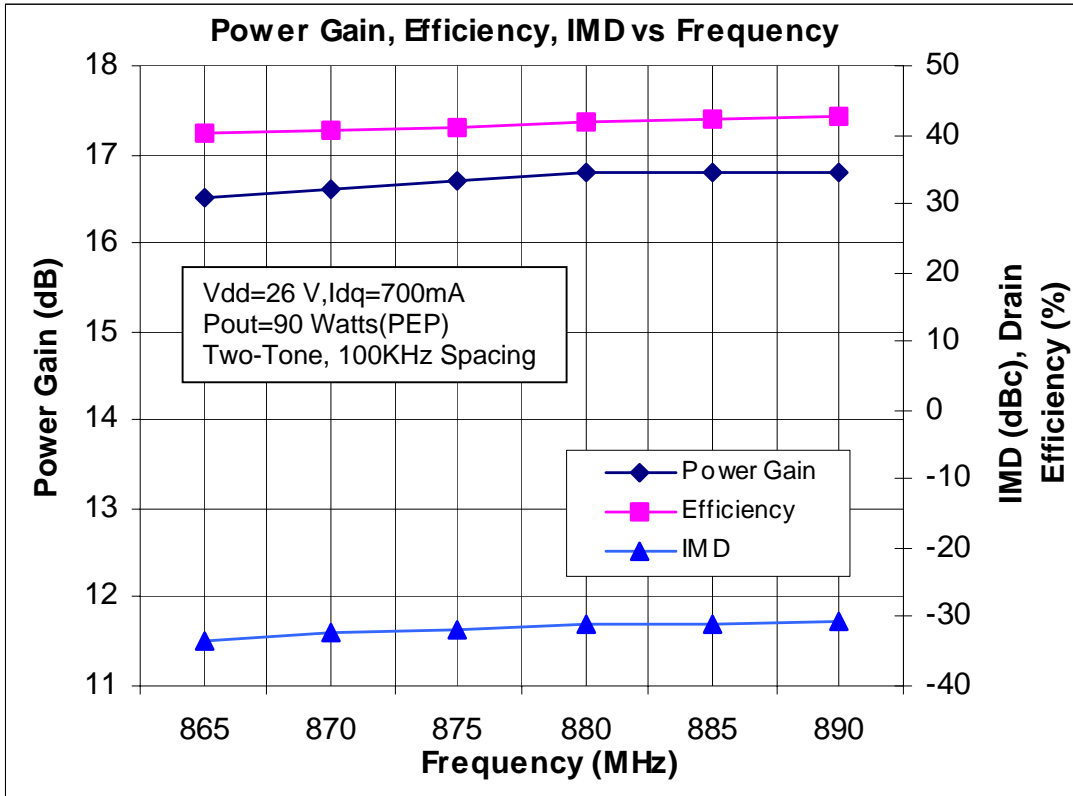
Rating	Symbol	Min	Typ	Max	Unit
CW. Power Gain, P <sub>out</sub> =90W V <sub>DD</sub> =26V, I <sub>DQ</sub> =700mA f= 865-880 MHz	G <sub>p</sub>	-	16	-	dB
CW. Output power @ 1dB compression point V <sub>DD</sub> =26V, I <sub>DQ</sub> =700mA f=880 MHz	P1dB	90	105	-	W
CW. Drain Efficiency, P <sub>out</sub> = 90 W, f=880 MHz, V <sub>DD</sub> =26V, I <sub>DQ</sub> =700mA	η <sub>D</sub>	-	45	-	%
Two-Tone Common-Source Amplifier Power Gain V <sub>DD</sub> =26V, I <sub>DQ</sub> =700mA, P <sub>out</sub> = 90 W PEP f <sub>1</sub> =880 MHz and f <sub>2</sub> =880.1 MHz	G <sub>TT</sub>	-	16.2	-	dB
Two-Tone Intermodulation Distortion V <sub>DD</sub> =26V, I <sub>DQ</sub> =700mA, P <sub>out</sub> = 90 W PEP f <sub>1</sub> =880 MHz and f <sub>2</sub> =880.1 MHz	I <sub>MD</sub>	-28.5	-30	-	dBc
Two-Tone Drain Efficiency V <sub>DD</sub> =26V, I <sub>DQ</sub> =700mA, P <sub>out</sub> = 90 W PEP f <sub>1</sub> =880 MHz and f <sub>2</sub> =880.1 MHz	η <sub>D2T</sub>	35	38	-	%
Input Return Loss V <sub>DD</sub> =26V, P <sub>out</sub> = 90 W PEP, I <sub>DQ</sub> =700mA f =865 - 880 MHz, Tone Spacing =100kHz	IRL	-	12	-	dB
Load Mismatch Tolerance V <sub>DS</sub> =26V, I <sub>DQ</sub> = 700 mA, P <sub>out</sub> =90W, f=880 MHz	VSWR	10:1	-	-	Ψ

Note: This transistor has been designed to work in the Motorola MRF9085 test fixture. Performance has been verified within that fixture.

**CAUTION** - MOS Devices are susceptible to damage from Electrostatic Discharge (ESD). Appropriate precautions in handling, packaging and testing MOS devices must be observed.







Note: Class AB broadband circuit performance.